

# 2SK2323(Tentative)

## Silicon N-Channel Power F-MOS

### ■ Features

- Avalanche energy capability guaranteed
- High-speed switching
- Low ON-resistance
- No secondary breakdown

### ■ Applications

- Non-contact relay
- Solenoid drive
- Motor drive
- Control equipment
- Switching mode regulator

### ■ Absolute Maximum Ratings (T<sub>c</sub> = 25°C)

Parameter	Symbol	Rating	Unit	
Drain-Source breakdown voltage	V <sub>DSS</sub>	600	V	
Gate-Source voltage	V <sub>GSS</sub>	±30	V	
Drain current	DC	I <sub>D</sub>	±1	A
	Pulse	I <sub>DP</sub>	±2	A
Avalanche energy capability	EAS*	2.5	mJ	
Allowable power dissipation	T <sub>C</sub> = 25°C	P <sub>D</sub>	40	W
	T <sub>a</sub> = 25°C		2	
Channel temperature	T <sub>ch</sub>	150	°C	
Storage temperature	T <sub>stg</sub>	-55 to +150	°C	

\* L= 5mH, I<sub>L</sub>=1A, 1 pulse

### ■ Electrical Characteristics (T<sub>c</sub> = 25°C)

Parameter	Symbol	Condition	Min	Typ	Max	Unit	
Drain-Source cut-off current	I <sub>DSS</sub>	V <sub>DS</sub> = 480V, V <sub>GS</sub> = 0			100	μA	
Gate-Source leakage current	I <sub>GSS</sub>	V <sub>GS</sub> = ±30V, V <sub>DS</sub> = 0			±1	μA	
Drain-Source breakdown voltage	V <sub>DSS</sub>	I <sub>D</sub> =1mA, V <sub>GS</sub> = 0	600			V	
Gate threshold voltage	V <sub>th</sub>	V <sub>DS</sub> = 25V, I <sub>D</sub> =1mA	2		5	V	
Drain-Source ON-resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> = 0.5A		5.8	8.5	Ω	
Forward transadmittance	Y <sub>fs</sub>	V <sub>DS</sub> = 25V, I <sub>D</sub> = 0.5A	0.32	0.54		S	
Diode forward voltage	V <sub>DSF</sub>	I <sub>DR</sub> =1A, V <sub>GS</sub> = 0			-1.5	V	
Input capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0, f=1MHz		280		pF	
Output capacitance	C <sub>oss</sub>				30		pF
Feedback capacitance	C <sub>rss</sub>				10		pF
Turn-on time (delay time)	t <sub>d(on)</sub>	V <sub>DD</sub> = 200V, I <sub>D</sub> = 0.5A V <sub>GS</sub> =10V, R <sub>L</sub> =400Ω		10		ns	
Rise time	t <sub>r</sub>				10		ns
Fall time	t <sub>f</sub>				50		ns
Turn-off time (delay time)	t <sub>d(off)</sub>				50		ns
Channel-Case heat resistance	R <sub>th(ch-c)</sub>					3.125	°C/W
Channel-Atmosphere heat resistance	R <sub>th(ch-a)</sub>				62.5	°C/W	

